July 1998



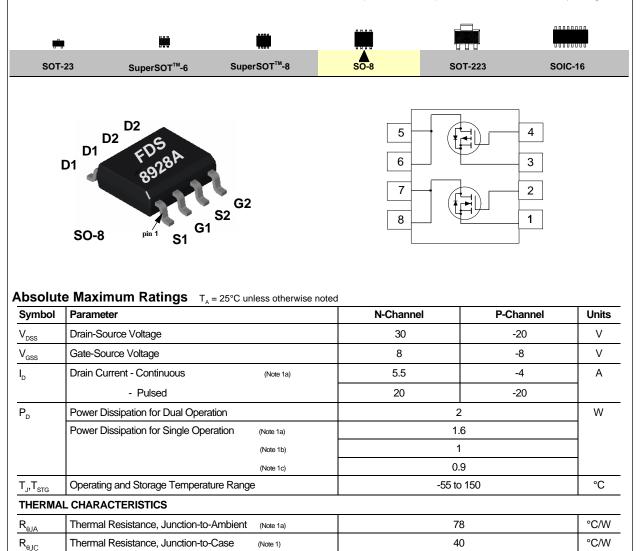
General Description

FAIRCHILD SEMICONDUCTOR IM

Features

These dual N- and P -Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

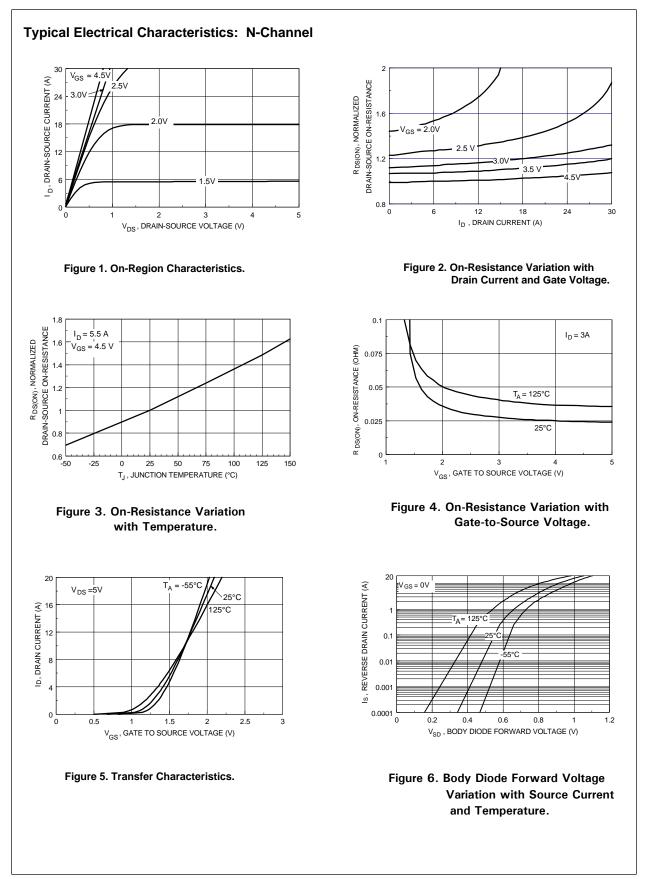
- $\label{eq:rescaled_$
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.
- Dual (N & P-Channel) MOSFET in surface mount package.

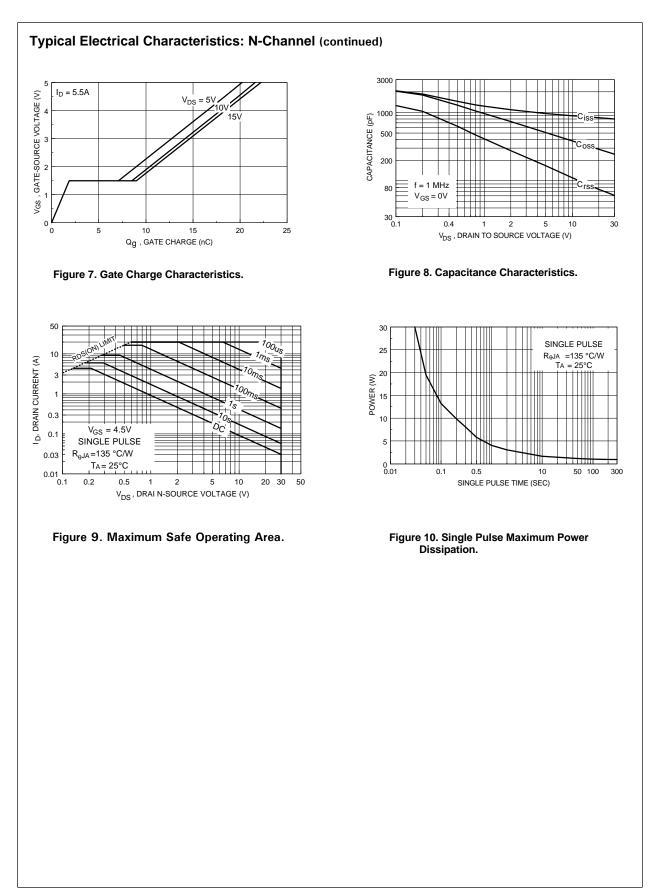


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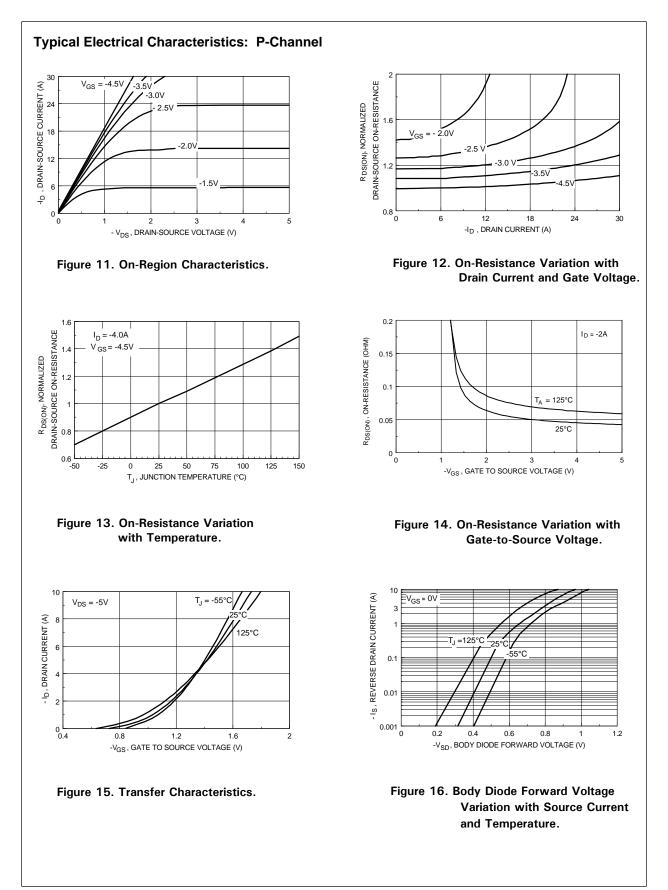
Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{gs} = 0 V, I _D = 250 µA	N-Ch	30			V
		V _{gs} = 0 V, I _D = -250 μA	P-Ch	-20			V
$\Delta \mathrm{BV}_\mathrm{DSS}/\Delta \mathrm{T}_\mathrm{J}$	Breakdown Voltage Temp. Coefficient	$I_D = 250 \mu\text{A}$, Referenced to $25 ^{\circ}\text{C}$	N-Ch		32		mV/°C
		$I_{\rm D}$ = -250 µA, Referenced to 25 °C	P-Ch		-23		
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\rm DS} = 24 \text{V}, \ V_{\rm GS} = 0 \text{V}$	N-Ch			1	μA
		$V_{\rm DS} = -16 \text{ V}, \ V_{\rm GS} = 0 \text{ V}$	P-Ch			-1	μA
	Gate - Body Leakage, Forward	$V_{gs} = 8 V, V_{Ds} = 0 V$	All			100	nA
	Gate - Body Leakage, Reverse	$V_{gg} = -8 V, V_{Dg} = 0 V$	All			-100	nA
ON CHARA	CTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{ps} = V_{qs}, I_{p} = 250 \mu A$	N-Ch	0.4	0.67	1	V
		$V_{ps} = V_{qs}, I_{p} = -250 \mu A$	P-Ch	-0.4	-0.6	-1	V
$\Delta V_{\rm GS(th)}\!/\!\Delta T_{\rm J}$	Gate Threshold Voltage Temp. Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to $25 \ ^{\circ}\text{C}$	N-Ch		-3		mV/°C
		I_{D} = -250 µA, Referenced to 25 °C	P-Ch		4		
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{gg} = 4.5 \text{ V}, I_{p} = 5.5 \text{ A}$	N-Ch		0.025	0.03	Ω
		$V_{gs} = 2.5 \text{ V}, I_p = 4.5 \text{ A}$			0.031		
		$V_{gg} = -4.5 \text{ V}, \text{ I}_{D} = -4 \text{ A}$	P-Ch		0.043	0.055	
		$V_{gs} = -2.5 \text{ V}, I_p = -3.4 \text{ A}$			0.059	0.072	
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	N-Ch	20			Α
		$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	P-Ch	-20			
g _{FS}	Forward Transconductance	$V_{\rm DS} = 5 \text{ V}, \text{ I}_{\rm D} = 5.5 \text{ A}$	N-Ch		20		S
		$V_{\rm DS} = -5 \text{ V}, \text{ I}_{\rm D} = -4 \text{ A}$	P-Ch		13		S
DYNAMIC (CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = 10 V, V_{GS} = 0 V, f = 1.0 MHz$	N-Ch		900		pF
		f = 1.0 MHz	P-Ch		1130		
C _{oss}	Input Capacitance		N-Ch		410		pF
		$V_{DS} = -10 V, V_{GS} = 0 V,$	P-Ch		480		
C _{rss}	Reverse Transfer Capacitance	f = 1.0 MHz	N-Ch		110		pF
			P-Ch		120		

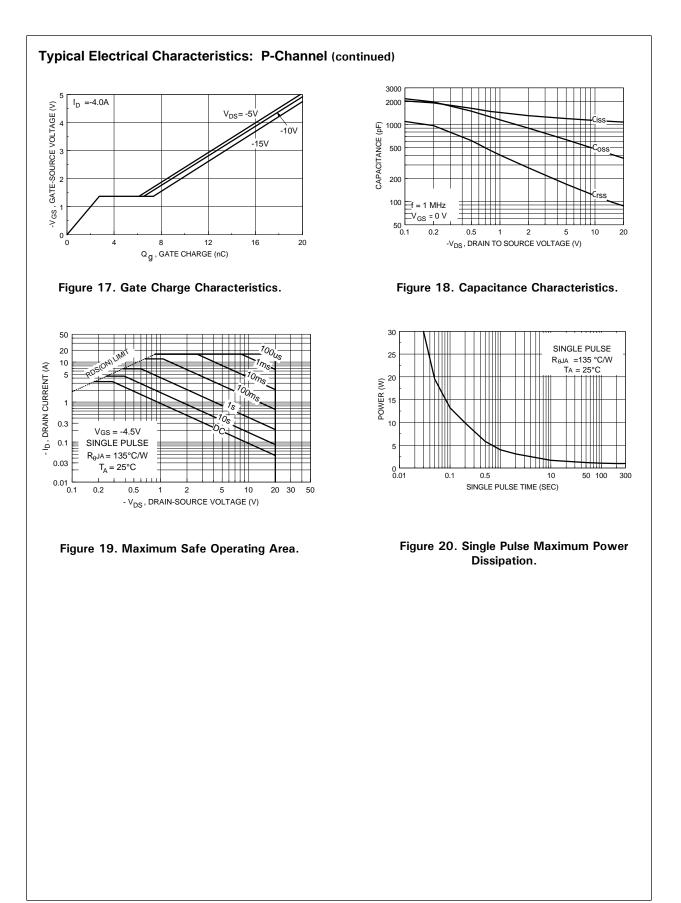
Symbol	IG CHARACTERISTICS (Note 2) Parameter	Conditions	Туре	Min	Тур	Max	Units
	Turn - On Delay Time	$V_{DS} = 6 \text{ V}, \text{ I}_{D} = 1 \text{ A}$	N-Ch	IVIIII	тур 6	12	
t _{D(on)}			P-Ch		8	12	ns
	Turn On Pige Time	$V_{\rm GS} = 4.5 \text{ V} , \ \text{R}_{\rm GEN} = 6 \Omega$			-	-	
t, Turn - On Rise Time	Turn - On Rise Time		N-Ch P-Ch		19	31 37	ns
+	Turn - Off Delay Time	V _{DS} = -10 V, I _D = -1 A	N-Ch		23 42	67	ns
t _{D(off)}		$V_{\rm DS} = -4.5 \text{ V}, R_{\rm GEN} = 6 \Omega$	P-Ch		260	360	115
t, T	Turn - Off Fall Time	$V_{GS} = -4.5 V$, $R_{GEN} = 0.52$	N-Ch		13	24	ns
			P-Ch		90	125	115
ຊຸ	Total Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5.5 \text{ A},$	N-Ch		19.8	28	nC
æ _g		$V_{DS} = 10^{\circ} V, T_{D} = 0.0^{\circ} A,$ $V_{GS} = 4.5^{\circ} V$	P-Ch		20	28	no
2	Gate-Source Charge	• _{GS} = +.0 •	N-Ch		2	20	nC
Q _{gs} Gate-Source Charge		$V_{DS} = -5 V, I_{D} = -4 A,$	P-Ch		2.8		
Q _{gd}	Gate-Drain Charge	$V_{GS} = -5 V$	N-Ch		6.3		nC
-gu		65 -	P-Ch		3.2		
DRAIN-SO	DURCE DIODE CHARACTERISTICS AND N	MAXIMUM RATINGS	I				
		Forward Current	N-Ch			1.3	А
l _s	Maximum Continuous Drain-Source Diode						
l _s	Maximum Continuous Drain-Source Diode		P-Ch			-1.3	А
I _s V _{sd}	Maximum Continuous Drain-Source Diode Drain-Source Diode Forward Voltage	$V_{gs} = 0 \text{ V}, \text{ I}_{s} = 1.3 \text{ A} \text{ (Note 2)}$	P-Ch N-Ch		0.68	-1.3 1.2	A V
V _{SD} otes: 1. R _{⊕JA} is the s		$\frac{V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}}{V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}}$	N-Ch P-Ch	surface of t	-0.7	1.2 -1.2	V V
V _{SD} lotes: 1. R _{8JA} is the s	Drain-Source Diode Forward Voltage	$\frac{V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}}{V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}}$	N-Ch P-Ch		-0.7	1.2 -1.2	V V aranteed by
V _{SD} lotes: 1. R _{ava} is the s design while	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}$ The where the case thermal reference is defined as the s	N-Ch P-Ch		-0.7	1.2 -1.2 R _{өлс} is gua	V V aranteed by
V _{SD} lotes: 1. R _{BAA} is the s design while	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}$ The where the case thermal reference is defined as the s	N-Ch P-Ch		-0.7	1.2 -1.2 R _{өлс} is gua	V V aranteed by
V _{SD} lotes: 1. R _{ava} is the s design while C C C C C Scale 1 : 1 (Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}$ The where the case thermal reference is defined as the s	N-Ch P-Ch		-0.7	1.2 -1.2 R _{өлс} is gua	V V aranteed by
V _{SD} lotes: 1. R _{ava} is the s design while C C C C C Scale 1 : 1 (Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}$ The where the case thermal reference is defined as the s	N-Ch P-Ch		-0.7	1.2 -1.2 R _{өлс} is gua	V V aranteed by
V _{SD} lotes: 1. R _{ava} is the s design while C C C C C Scale 1 : 1 (Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}$ The where the case thermal reference is defined as the s	N-Ch P-Ch		-0.7	1.2 -1.2 R _{өлс} is gua	V V aranteed by
V _{SD} lotes: 1. R _{ava} is the s design while C C C C C Scale 1 : 1 (Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}$ The where the case thermal reference is defined as the s	N-Ch P-Ch		-0.7	1.2 -1.2 R _{өлс} is gua	V V aranteed by
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V _{SD} lotes: 1. R _{BAA} is the s design while	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}$ The where the case thermal reference is defined as the s	N-Ch P-Ch		-0.7	1.2 -1.2 R _{өлс} is gua	V V aranteed by
V _{SD} lotes: 1. R _{ava} is the s design while C C C C C Scale 1 : 1 (Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}$ The where the case thermal reference is defined as the s	N-Ch P-Ch		-0.7	1.2 -1.2 R _{өлс} is gua	V V aranteed by
V _{SD} lotes: 1. R _{BAA} is the s design while	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}$ The where the case thermal reference is defined as the s	N-Ch P-Ch		-0.7	1.2 -1.2 R _{өлс} is gua	V V aranteed by



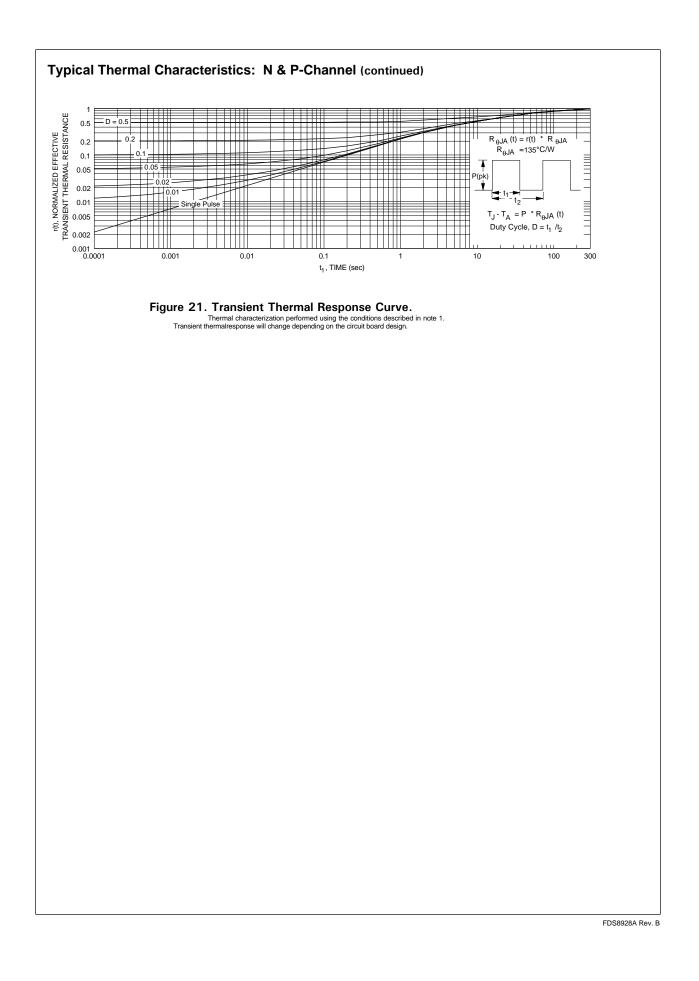


FDS8928A Rev. B





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